

ABSTRACT OF THE DISCLOSURE

The invention provides a wiring structure and a method for manufacturing the same for appropriately establishing an electrical connection between a first conductive layer constituting a part of a laminate and a conductive layer to be electrically connected thereto. The wiring structure can include, on a substrate, a capacitor provided with a first conductive layer, an insulating layer formed on the first conductive layer, and a second conductive layer formed on the insulating layer, a conductive layer electrically connected to the first conductive layer, and a relay layer located below the first conductive layer and the conductive layer, respectively to form a part of laminated structure. The first conductive layer and the conductive layer are electrically connected to each other through the relay layer.